FORM **PTO-1595** (Rev. 10/02) OMD No. 0651-0011 (exp. 6/30/2005)

09-16-2005 103082994

.S. DEPARTMENT OF COMMERCE Patent and Trademark Office

Name of conveying party(ies): Hyung-Suk You; Seong-Cheol Byun	2. Name and address of receiving party(ies):	
and the second current and and	Name: MagnaChip Semiconductor, Ltd.	
Additional name(s) of conveying party(ies) attached? ☑ No ☐ Yes	Street Address: Street Address: 1 Hyangjeong-dong, Heungduk-gu, Cheongju-s City: Chungcheongbuk-do State: ZIP: 36	
3. Nature of Conveyance: ☑ Assignment ☐ Merger		
☐ Security Agreement ☐ Change of Name ☐ Other		
Execution Date: 08/24/2005	Country: Republic of Korea Additional name(s)& address(es) attached? \[\subseteq No \subseteq Y	
Application number(s) or patent number(s): If this document is being filed together with a new appli	lication, the execution date of the application is: $_08$	
A. Patent Application No.(s)	B. Patent No.(s)	
Additional numbers atta	uched? ⊠ No □ Yes	
Name and address of party to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved	
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Docket No. 51876P932

ASSIGNMENT

In consideration of good and valuable consideration, the receipt of which is hereby acknowledged, the undersigned, YOU, Hyung-Suk and Byun, Seong-Cheol

Hereby sells, assigns, and transfers to:

MagnaChip Semiconductor, Ltd.

a corporation of Republic of Korea, having a principal place of business at: 1 Hyangjeong-dong, Heungduk-gu, Cheongju-si, Chungcheongbuk-do, 361-725, Republic of Korea ("Assignee"), and its successors, assigns and legal representatives, the entire right, title and interest for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent,

<u>I X</u>	_ which has been	executed by the under	signed concurrently her	ewith,
<u></u>	_] which was filed	l	and assigned Serial No.	

and is entitled:

SHUTTER MODULE FOR USE IN IMAGE SENSOR EMPLOYING LINE SCAN AND METHOD FOR CONTROLLING THE SAME

and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be issued in the United States and all foreign countries on said improvements; and in and to all rights of priority resulting from the filing of said United States application;

Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to, but at the expense of, said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this Assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and representatives, all facts known to the undersigned relating to said improvements and the history thereof: and generally do everything possible which said Assignee, its successors, assigns or representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

Date: 8./24, 2005

Date: 3/24, 2005

RECORDED: 09/08/2005

PATENT

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